



CP 250.1
ATTORNEY DOCKET NO. 6605-9
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)
Paul Poenisch et al.)
Serial No.: 08/478,114)
Filed: June 7, 1995)
For: LOW COST, HIGH PERFORMANCE)
FLIP-CHIP BONDING TECHNIQUE)

Attn:

APPLICATIONS BRANCH

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DEC 26 1995
GROUP 1

INFORMATION DISCLOSURE STATEMENT

Hon. Commissioner of Patents
and Trademarks
Washington, D.C. 20231

Sir:

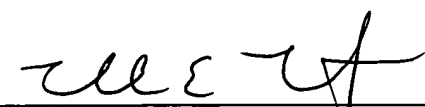
In accordance with the duty of disclosure under 37 C.F.R.
§§ 1.56 and 1.98, Applicants bring to the attention of the U.S.
Patent and Trademark Office the prior art references listed on
the attached Form PTO-1449.

Respectfully submitted,

WILLIAN BRINKS HOFER
GILSON & LIONE

Date: November 1, 1995

By:


Michael E. Fogarty
Registration No. 36,139

2000 K Street, N.W., Suite 200
Washington, D.C. 20006-1809
(202) 429-0625